TSF30L45C -	TSF30L60C
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# 30A, 45V - 60V Trench Schottky Rectifier

### FEATURES

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- Patented Trench Schottky technology
- Excellent high temperature stability
- Low forward voltage
- Low power loss/ high efficiency
- High forward surge capability
- Compliant RoHS
- Halogen-free according to IEC 61249-2-21

## APPLICATIONS

- Switching mode power supply (SMPS)
- Adapters
- Lighting application
- On-board DC/DC converter

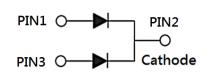
## **MECHANICAL DATA**

- Case: ITO-220AB
- Molding compound meets UL 94V-0 flammability rating
- Terminal: Matte tin plated leads, solderable per J-STD-002
- Meet JESD 201 class 2 whisker test
- Mounting torque: 0.56 N·m maximum
- Polarity: As marked
- Weight: 1.70g (approximately)

KEY PARAMETERS			
PARAMETER	VALUE	UNIT	
I <sub>F</sub>	30	А	
V <sub>RRM</sub>	45 - 60	V	
I <sub>FSM</sub>	180	А	
T <sub>J MAX</sub>	150	°C	
Package	ITO-220AB		
Configuration	Dual d	lies	







ABSOLUTE MAXIMUM RATINGS (T <sub>A</sub> = 25°C unless otherwise noted)				
PARAMETER	SYMBOL	TSF30L45C	TSF30L60C	UNIT
Marking code on the device		TSF30L45C	TSF30L60C	
Repetitive peak reverse voltage	V <sub>RRM</sub>	45	60	V
Reverse voltage, total rms value	V <sub>R(RMS)</sub>	31	42	V
Forward current	I <sub>F</sub>	30		А
Surge peak forward current, 8.3ms single half sine-wave superimposed on rated load	I <sub>FSM</sub>	180		А
Critical rate of rise of off-state voltage	dv/dt	10,000		V/µs
Junction temperature	TJ	-55 to +150		°C
Storage temperature	T <sub>STG</sub>	-55 to +150		°C





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THERMAL PERFORMANCE			
PARAMETER	SYMBOL	ТҮР	UNIT
Junction-to-case thermal resistance	R <sub>eJC</sub>	4	°C/W

ELECTRICAL SPECIFICATIONS (T <sub>A</sub> = 25°C unless otherwise noted)						
PARAMETER		CONDITIONS	SYMBOL	ТҮР	MAX	UNIT
	TSF30L45C	I <sub>-</sub> = 15Δ T <sub>-</sub> = 25°C		0.48	0.55	V
Forward voltage per diode <sup>(1)</sup>	TSF30L60C		V <sub>F</sub>	0.55	0.62	V
	TSF30L45C	I <sub>F</sub> = 15A, T <sub>J</sub> = 125°C		0.46	0.53	V
	TSF30L60C			0.51	0.58	V
Reverse current @ rated $V_R$ per diode <sup>(2)</sup>		$T_J = 25^{\circ}C$	- I <sub>R</sub>	-	500	μA
		T <sub>J</sub> = 125°C		-	60	mA

#### Notes:

1. Pulse test with PW = 0.3ms

2. Pulse test with PW = 30ms

ORDERING INFORMATION		
ORDERING CODE <sup>(1)</sup>	PACKAGE	PACKING
TSF30LxC	ITO-220AB	50 / Tube

Notes:

1. "x" defines voltage from 45V(TSF30L45C) to 60V(TSF30L60C)



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#### **CHARACTERISTICS CURVES**

 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$ 

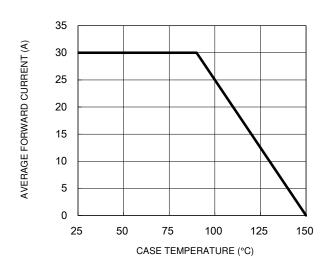
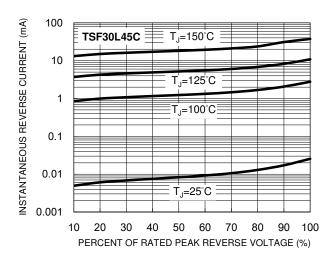
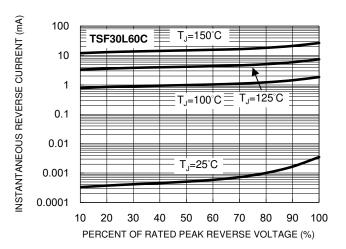


Fig.1 Forward Current Derating Curve

**Fig.3 Typical Reverse Characteristics** 



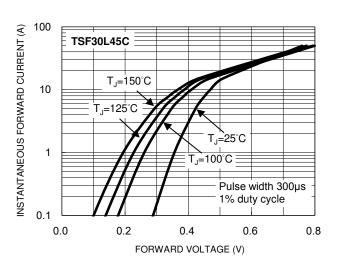
**Fig.5 Typical Reverse Characteristics** 



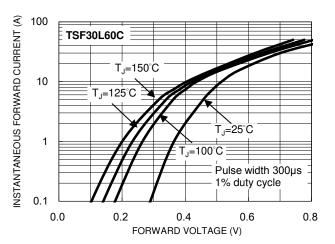
10000 (g) 1000 100 100 100 (g) 1000 (g)

#### Fig.2 Typical Junction Capacitance

**Fig.4 Typical Forward Characteristics** 



**Fig.6 Typical Forward Characteristics** 

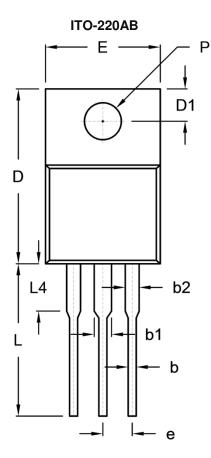


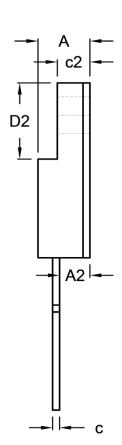


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## PACKAGE OUTLINE DIMENSIONS





DIM.	Unit (mm)		Unit	(inch)
	Min.	Max.	Min.	Max.
A	4.30	4.70	0.169	0.185
A2	2.30	2.96	0.091	0.117
b	0.50	0.90	0.020	0.035
b1	-	1.80	-	0.071
b2	0.95	1.45	0.037	0.057
с	0.46	0.76	0.018	0.030
c2	2.50	3.16	0.098	0.124
D	14.80	15.50	0.583	0.610
D1	2.40	3.20	0.094	0.126
D2	6.30	6.90	0.248	0.272
E	9.60	10.30	0.378	0.406
е	2.41	2.67	0.095	0.105
L	12.60	13.80	0.496	0.543
L4	-	4.10	-	0.161
Р	3.00	3.40	0.118	0.134

### **MARKING DIAGRAM**



= Marking Code
= Green Compound
= Date Code
= Factory Code



## TSF30L45C – TSF30L60C

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